SN54HCT373, SN74HCT373 OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

SCLS009D - MARCH 1984 - REVISED AUGUST 2003

- Operating Voltage Range of 4.5 V to 5.5 V
- High-Current 3-State True Outputs Can Drive Up To 15 LSTTL Loads
- Low Power Consumption, 80-µA Max ICC
- Typical t_{pd} = 21 ns
- ±6-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Inputs Are TTL-Voltage Compatible
- Eight High-Current Latches in a Single Package
- Full Parallel Access for Loading

description/ordering information

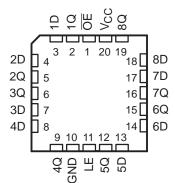
These 8-bit latches feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight latches of the 'HCT373 devices are transparent D-type latches. While the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the levels that were set up at the D inputs.

SN54HCT373J OR W PACKAGE									
SN74HCT373DB, DW, N, NS, OR PW PACKAGE									
(TOP VIEW)									

OE		$\mathbf{\nabla}_{i}$	20] v _{cc}
1Q	2		19] 8Q
1D	[] 3		18] 8D
2D	4		17]7D
2Q	5		16] 7Q
3Q	6		15] 6Q
3D	[7		14] 6D
4D	8]		13] 5D
4Q	[9		12] 5Q
GND	[10		11] LE

SN54HCT373 . . .FK PACKAGE (TOP VIEW)



TA	PACKAG	GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube of 20	SN74HCT373N	SN74HCT373N
-40°C to 85°C	SOIC - DW	Tube of 25	SN74HCT373DW	НСТ373
	3010 - 010	Reel of 2000	SN74HCT373DWR	ПС1373
	SOP – NS	Reel of 2000	SN74HCT373NSR	HCT373
-40 C 10 85 C	SSOP – DB	Reel of 2000	SN74HCT373DBR	HT373
		Tube of 70	SN74HCT373PW	
	TSSOP – PW	Reel of 2000	SN74HCT373PWR	HT373
		Reel of 250	SN74HCT373PWT	
	CDIP – J	Tube of 20	SNJ54HCT373J	SNJ54HCT373J
–55°C to 125°C	CFP – W	Tube of 85	SNJ54HCT373W	SNJ54HCT373W
	LCCC – FK	Tube of 55	SNJ54HCT373FK	SNJ54HCT373FK

ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 2003, Texas Instruments Incorporated On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

SN54HCT373, SN74HCT373 OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS SCLS009D – MARCH 1984 – REVISED AUGUST 2003

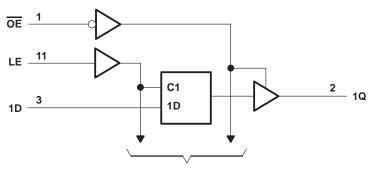
description/ordering information (continued)

An output-enable (\overline{OE}) input places the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

OE does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are off.

	FUNCTION TABLE (each latch)										
	INPUTS	OUTPUT									
OE	LE	D	Q								
L	Н	Н	Н								
L	Н	L	L								
L	L	Х	Q ₀								
н	Х	Х	Z								

logic diagram (positive logic)



To Seven Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

DW package
N package
NS package
PW package
Storage temperature range, T _{stg} –65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



SN54HCT373, SN74HCT373 OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

SCLS009D - MARCH 1984 - REVISED AUGUST 2003

recommended operating conditions (see Note 3)

			SN54HCT373			SN	74HCT3	73	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	V_{CC} = 4.5 V to 5.5 V	2			2			V
VIL	Low-level input voltage	V_{CC} = 4.5 V to 5.5 V			0.8			0.8	V
VI	Input voltage		0		VCC	0		VCC	V
Vo	Output voltage		0		VCC	0		VCC	V
$\Delta t/\Delta v$	Input transition rise/fall time				500			500	ns
Т _А	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		Vaa	Т	A = 25°C	;	SN54HCT373		SN74HCT373		UNIT
FARAMETER	TEST CO	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
VOH	$\lambda = \lambda = 0$	I _{OH} = -20 μA	4.5 V	4.4	4.499		4.4		4.4		V
VOH	$V_{I} = V_{IH} \text{ or } V_{IL}$	I _{OH} =6 mA	4.5 V	3.98	4.3		3.7		3.84		v
Ve	$\lambda = \lambda = 0$	I _{OL} = 20 μA	4.5 V		0.001	0.1		0.1		0.1	V
VOL	$V_{I} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 6 \text{ mA}$			0.17	0.26		0.4		0.33	v
Ц	$V_I = V_{CC} \text{ or } 0$		5.5 V		±0.1	±100		±1000		±1000	nA
IOZ	AO = ACC or 0		5.5 V		±0.01	±0.5		±10		±5	μΑ
ICC	$V_I = V_{CC} \text{ or } 0,$	$I_{O} = 0$	5.5 V			8		160		80	μΑ
∆lCC‡	One input at 0.5 V Other inputs at 0 or		5.5 V		1.4	2.4		3		2.9	mA
Ci			4.5 V to 5.5 V		3	10		10		10	pF

[†] This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V_{CC}.

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		Vaa	T _A = 25°C		SN54HCT373		SN74HCT373		UNIT
		Vcc	MIN	MAX	MIN	MAX	MIN	MAX	UNIT
t Pulso duration	Pulse duration, LE high	4.5 V	20		30		25		ns
tw	Fuise duration, LE nigh	5.5 V	17		27		23		
		4.5 V	10		15		13		ns
t _{su}	Setup time, data before LE \downarrow	5.5 V	9		14		12		
+.	Hold time. data after LE↓	4.5 V	10		10		10		
^t h		5.5 V	10		10		10		ns



SN54HCT373, SN74HCT373 **OCTAL TRANSPARENT D-TYPE LATCHES** WITH 3-STATE OUTPUTS SCLS009D - MARCH 1984 - REVISED AUGUST 2003

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	Vee	Τ ₄	λ = 25°C	;	SN54H	CT373	SN74H0	CT373	UNIT	
FARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
	D	Q	4.5 V		25	35		53		44		
^t pd	D	Q	5.5 V		21	32		48		40	ns	
	LE	Any Q	4.5 V		28	35		53		44	115	
		Ally Q	5.5 V		25	32		48		40		
+	OE	Any O	4.5 V		26	35		53		44	ns	
ten	ÛE	Any Q	Ally Q	5.5 V		23	32		48		40	115
*	OE	Any Q	4.5 V		23	35		53		44	ns	
^t dis	ÛE	Ally Q	5.5 V		22	32		48		40	115	
+.		Any Q	4.5 V		10	12		18		15	ns	
t			5.5 V		9	11		16		14	115	

switching characteristics over recommended operating free-air temperature range, $C_L = 150 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	Vee	Тį	Δ = 25°C	;	SN54H	СТ373	SN74H	CT373	UNIT
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	D	Q	4.5 V		32	52		79		65	
^t pd	D	Q	5.5 V		27	47		71		59	-
	LE	Any Q	4.5 V		38	52		79		65	ns
		Ally Q	5.5 V		36	47		71		59	59
+	5	Any Q	4.5 V		33	52		79		65	00
^t en	ŌĒ	Any Q	5.5 V		28	47		71		59	ns
+.		Any 0	4.5 V		18	42		63		53	00
tt		Any Q	5.5 V		16	38		57		48	ns

operating characteristics, $T_A = 25^{\circ}C$

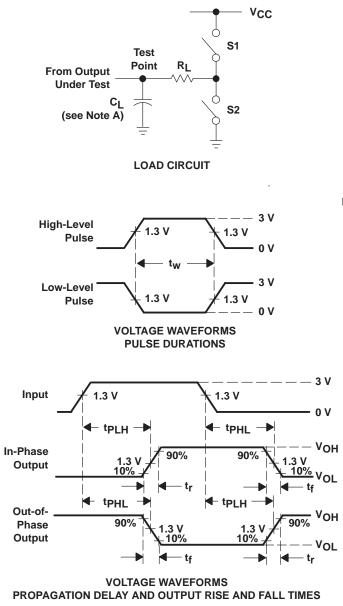
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per latch	No load	50	pF

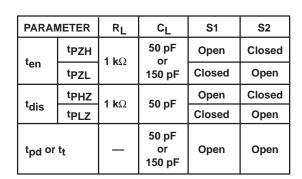


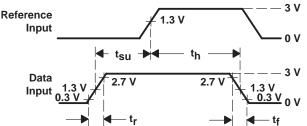
SN54HCT373, SN74HCT373 **OCTAL TRANSPARENT D-TYPE LATCHES** WITH 3-STATE OUTPUTS

SCLS009D - MARCH 1984 - REVISED AUGUST 2003

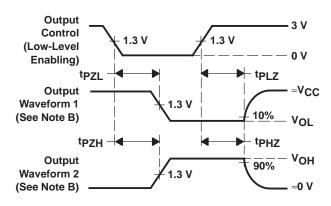
PARAMETER MEASUREMENT INFORMATION







VOLTAGE WAVEFORMS SETUP AND HOLD AND INPUT RISE AND FALL TIMES



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

- NOTES: A. CL includes probe and test-fixture capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following
 - characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_r = 6 ns, t_f = 6 ns.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. tPLZ and tPHZ are the same as tdis.
 - F. tp71 and tp7H are the same as ten.
 - G. tPLH and tPHL are the same as tpd.





28-Feb-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	n MSL Peak Temp ⁽³⁾
5962-86867012A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-8686701RA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
5962-8686701VRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
5962-8686701VSA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
JM38510/65453BRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
JM38510/65453BSA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SN54HCT373J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN74HCT373DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74HCT373DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74HCT373N	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74HCT373N3	OBSOLETE	PDIP	Ν	20		None	Call TI	Call TI
SN74HCT373NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74HCT373PW	ACTIVE	TSSOP	PW	20	70	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74HCT373PWLE	OBSOLETE	TSSOP	PW	20		None	Call TI	Call TI
SN74HCT373PWR	ACTIVE	TSSOP	PW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74HCT373PWT	ACTIVE	TSSOP	PW	20	250	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SNJ54HCT373FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54HCT373J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54HCT373W	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on

PACKAGE OPTION ADDENDUM



incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within Mil-Std 1835 GDFP2-F20



MLCC006B - OCTOBER 1996

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AC.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address:

Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated

This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.